

Is Now Part of



## **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese





## 74LCX240 Low Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs

**General Description** 

ing CMOS low power dissipation.

environment.

The LCX240 is an inverting octal buffer and line driver designed to be employed as a memory address driver,

clock driver and bus oriented transmitter or receiver. The

device is designed for low voltage (2.5V or 3.3V) V<sub>CC</sub>

applications with capability of interfacing to a 5V signal

The LCX240 is fabricated with an advanced CMOS tech-

nology to achieve high speed operation while maintain-

## Features

- 5V tolerant inputs and outputs
- 2.3V–3.6V V<sub>CC</sub> specifications provided
- 6.5ns t<sub>PD</sub> max. (V<sub>CC</sub> = 3.3V), 10µA I<sub>CC</sub> max.
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal<sup>(1)</sup>
- $\pm 24$ mA output drive (V<sub>CC</sub> = 3.0V)
- Implements proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds 500mA
- ESD performance:
  - Human body model > 2000V
  - Machine model > 200V

#### Note:

 To ensure the high-impedance state during power up or down, OE should be tied to V<sub>CC</sub> through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

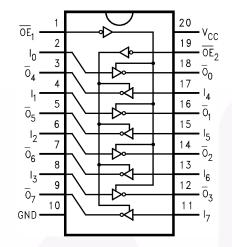
## **Ordering Information**

#### Order Package **Package Description** Number Number 74LCX240WM M20B 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide 74LCX240SJ M20D 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide 74LCX240MSA MSA20 20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide 74LCX240MTC MTC20 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

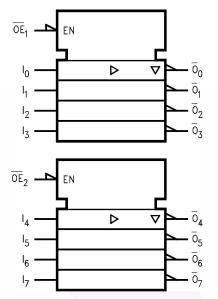
## **Connection Diagram**



## **Pin Description**

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	3-STATE Output Enable Inputs
I <sub>0</sub> —I <sub>7</sub>	Inputs
$\overline{O}_0 - \overline{O}_7$	Outputs

Logic Diagram



## **Truth Tables**

Inputs		Outputs
OE <sub>1</sub>	I <sub>n</sub>	(Pins 12, 14, 16, 18)
L	L	Н
L	Н	L
Н	Х	Z

Inputs		Outputs
OE <sub>2</sub>	I <sub>n</sub>	(Pins 3, 5, 7, 9)
L	L	Н
L	Н	L
Н	Х	Z

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = High Impedance

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	-0.5V to +7.0V
VI	DC Input Voltage	-0.5V to +7.0V
Vo	DC Output Voltage	
	Output in 3-STATE	-0.5V to +7.0V
	Output in HIGH or LOW State <sup>(2)</sup>	–0.5V to V <sub>CC</sub> + 0.5V
I <sub>IK</sub>	DC Input Diode Current, V <sub>I</sub> < GND	–50mA
I <sub>OK</sub>	DC Output Diode Current	
	V <sub>O</sub> < GND	–50mA
	V <sub>O</sub> > V <sub>CC</sub>	+50mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current	±50mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100mA
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C

Note:

2. I<sub>O</sub> Absolute Maximum Rating must be observed.

## Recommended Operating Conditions<sup>(3)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units	
V <sub>CC</sub>	Supply Voltage				
	Operating	2.0	3.6	V	
	Data Retention	1.5	3.6		
VI	Input Voltage	0	5.5	V	
Vo	Output Voltage				
	3-STATE	0	5.5	V	
	HIGH or LOW State	0	V <sub>CC</sub>	-	
I <sub>OH</sub> / I <sub>OL</sub>	Output Current				
	$V_{CC} = 3.0V - 3.6V$		±24	mA	
	$V_{CC} = 2.7V - 3.0V$		±12	1 D	
	V <sub>CC</sub> = 2.3V–2.7V		±8		
T <sub>A</sub>	Free-Air Operating Temperature	-40	85	°C	
$\Delta t / \Delta V$	Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V	0	10	ns/V	

#### Note:

3. Unused inputs must be held HIGH or LOW. They may not float.

## **DC Electrical Characteristics**

				$T_A = -40^{\circ}C$	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min.	Max.	Units
V <sub>IH</sub>	HIGH Level Input Voltage	2.3–2.7		1.7		V
		2.7–3.6		2.0		
V <sub>IL</sub>	LOW Level Input Voltage	2.3–2.7			0.7	V
		2.7–3.6			0.8	
V <sub>OH</sub>	HIGH Level Output Voltage	2.3–3.6	$I_{OH} = -100 \mu A$	V <sub>CC</sub> – 0.2		V
		2.3	$I_{OH} = -8mA$	1.8		
	2.7	$I_{OH} = -12mA$	2.2			
	3.0	$I_{OH} = -18mA$	2.4			
			$I_{OH} = -24mA$	2.2		
V <sub>OL</sub>	LOW Level Output Voltage	2.3–3.6	$I_{OL} = 100 \mu A$		0.2	V
		2.3	$I_{OL} = 8mA$		0.6	
		2.7	$I_{OL} = 12mA$		0.4	
		3.0	$I_{OL} = 16 \text{mA}$		0.4	
			$I_{OL} = 24 \text{mA}$		0.55	
I	Input Leakage Current	2.3–3.6	$0 \le V_I \le 5.5V$		±5.0	μA
I <sub>OFF</sub>	Power-Off Leakage Current		$V_{\rm I}$ or $V_{\rm O} = 5.5 V$		10	μA
I <sub>CC</sub> Quiescent Supply (	Quiescent Supply Current	2.3–3.6	$V_I = V_{CC}$ or GND		10	μA
			$3.6V \le V_{I}, V_{O} \le 5.5V^{(4)}$		±10	
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	2.3–3.6	$V_{IH} = V_{CC} = 0.6V$		500	μA

#### Note:

4. Outputs disabled or 3-STATE only.

## **AC Electrical Characteristics**

	$T_A = -40^{\circ}C$ to +85°C, $R_L = 500\Omega$							
			3V ± 0.3V, 50pF		2.7V, 50pF	V <sub>CC</sub> = 2.5 C <sub>L</sub> =	V ± 0.2V, 30pF	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Units
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	1.5	6.5	1.5	7.5	1.5	7.8	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time	1.5	8.0	1.5	9.0	1.5	10.0	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>OSHL</sub> , t <sub>OSLH</sub>	Output to Output Skew <sup>(5)</sup>		1.0					ns

#### Note:

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

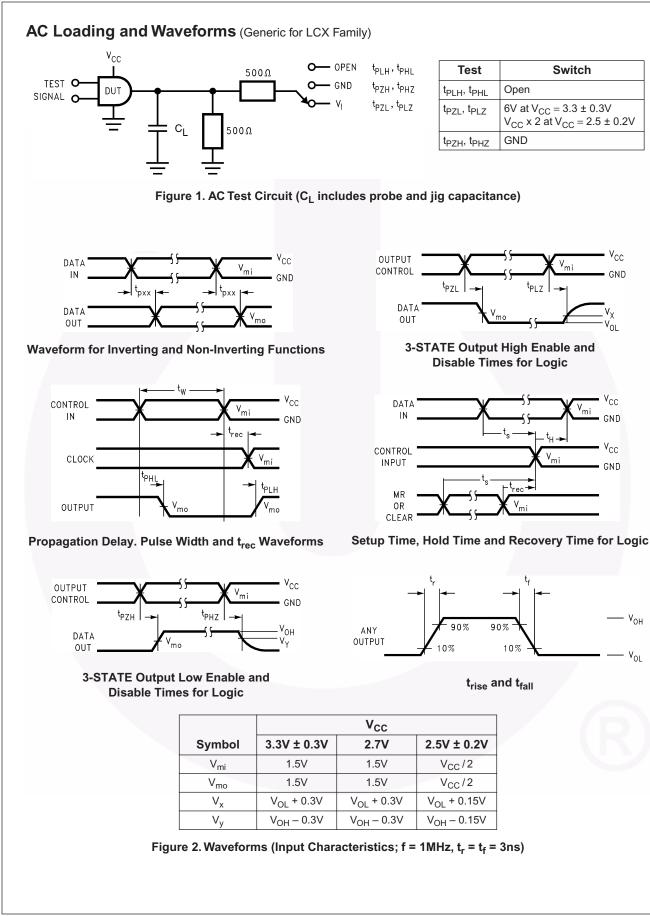
## **Dynamic Switching Characteristics**

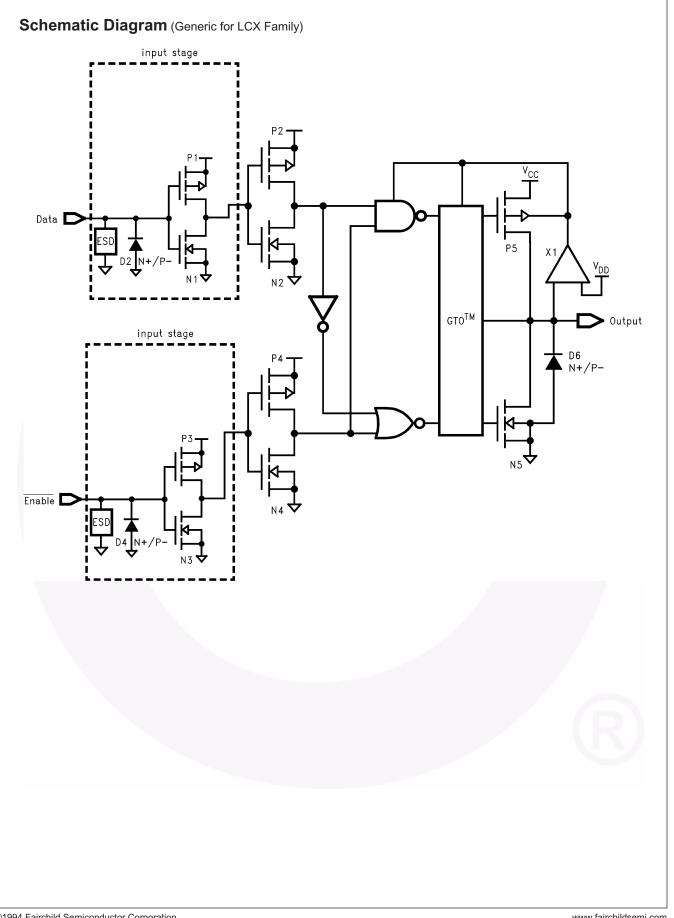
				$T_A = 25^{\circ}C$	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Typical	Unit
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	3.3	$C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$	0.8	V
		2.5	$C_L = 30 pF$ , $V_{IH} = 2.5 V$ , $V_{IL} = 0 V$	0.6	
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	3.3	$C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$	-0.8	V
		2.5	$C_{L} = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V$	-0.6	

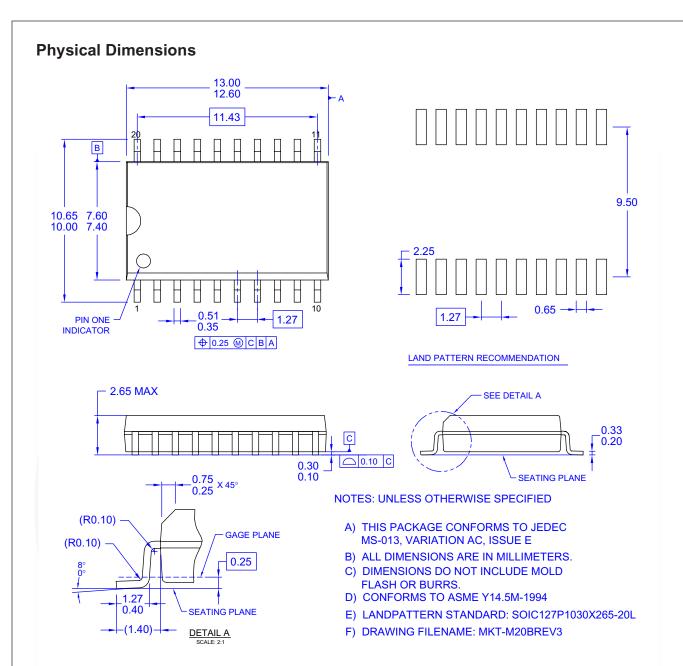
## Capacitance

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3 V$ , $V_I = 0 V$ or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$ , f = 10MHz	25	pF





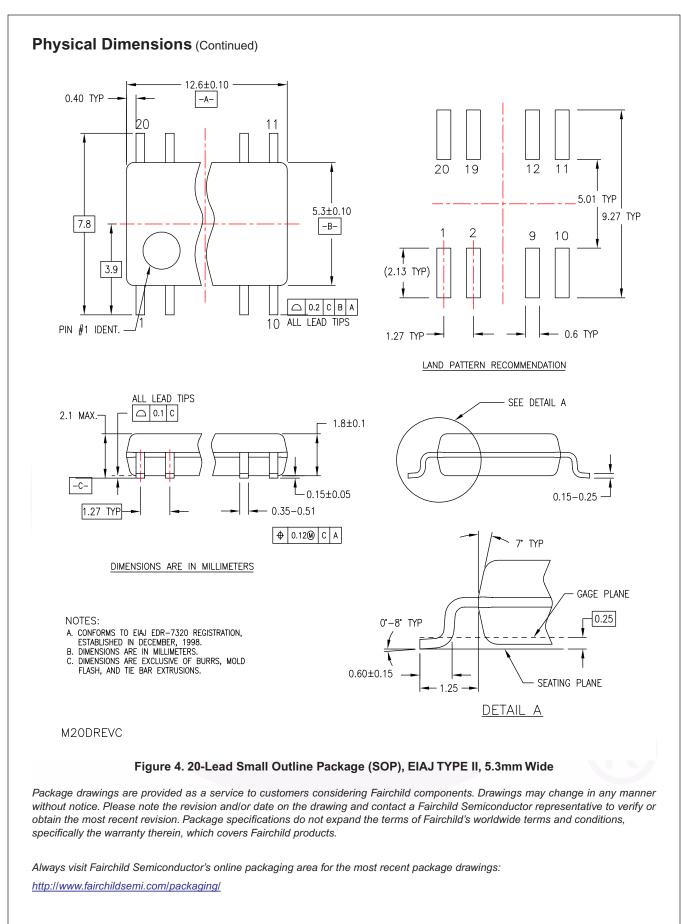


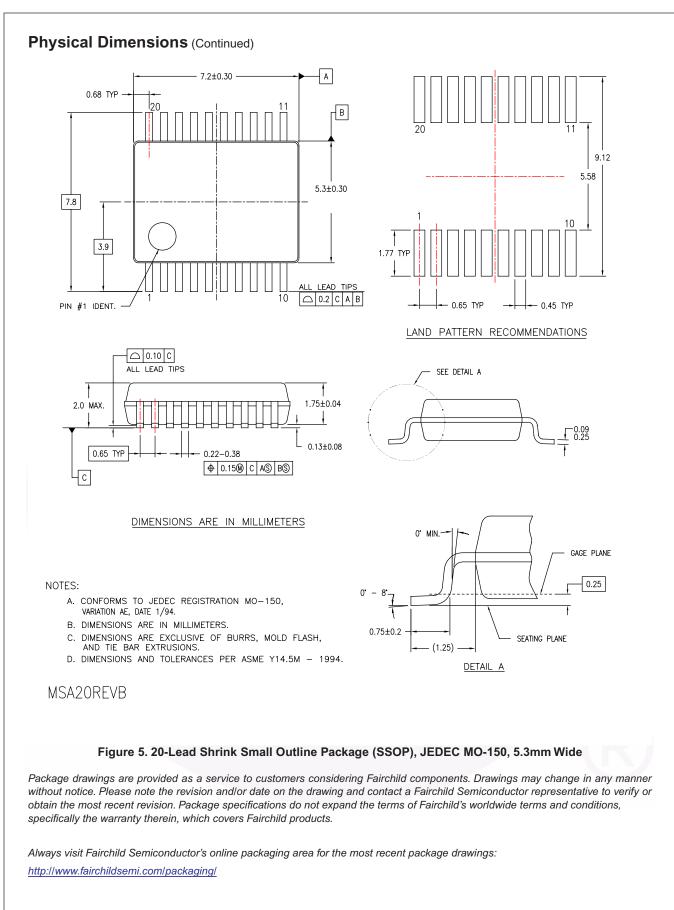


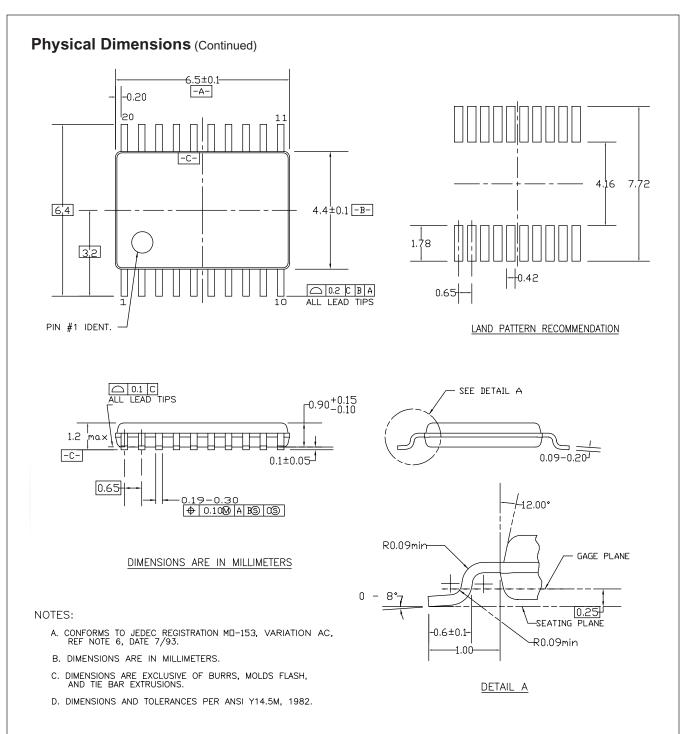
#### Figure 3. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <u>http://www.fairchildsemi.com/packaging/</u>







### MTC20REVD1

#### Figure 6. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/packaging/

74LCX240 — Low Voltage Octal Buffer/Line Driver with 5V Tolerant Inputs and Outputs



SEMICONDUCTOR

#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

ACE $x^{@}$ Build it Now <sup>TM</sup> CorePLUS <sup>TM</sup> CROSSVOLT <sup>TM</sup> CTL <sup>TM</sup> Current Transfer Logic <sup>TM</sup> EcoSPARK <sup>®</sup> EZSWITCH <sup>TM</sup> * $\overbrace{ex}^{TM}$ $\overbrace{ex}^{TM}$ Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild Semiconductor <sup>®</sup> FACT Quiet Series <sup>TM</sup> FACT <sup>®</sup> FAST <sup>®</sup> FastvCore <sup>TM</sup>	FPS <sup>™</sup> FRFET <sup>®</sup> Global Power Resource <sup>sM</sup> Green FPS <sup>™</sup> e-Series <sup>™</sup> GTO <sup>™</sup> <i>i-Lo</i> <sup>™</sup> IntelliMAX <sup>™</sup> ISOPLANAR <sup>™</sup> MegaBuck <sup>™</sup> MICROCOUPLER <sup>™</sup> MicroFET <sup>™</sup> MicroPak <sup>™</sup> MillerDrive <sup>™</sup> Motion-SPM <sup>™</sup> OPTOLOGIC <sup>®</sup> OPTOPLANAR <sup>®</sup>	PDP-SPM <sup>™</sup> Power220 <sup>®</sup> POWEREDGE <sup>®</sup> Power-SPM <sup>™</sup> PowerTrench <sup>®</sup> Programmable Active Droop <sup>™</sup> QFET <sup>®</sup> QS <sup>™</sup> QT Optoelectronics <sup>™</sup> Quiet Series <sup>™</sup> RapidConfigure <sup>™</sup> SMART START <sup>™</sup> SMART START <sup>™</sup> SUperFET <sup>™</sup> SuperSOT <sup>™</sup> 46	SupreMOS <sup>™</sup> SyncFET <sup>™</sup> System <sup>®</sup> The Power Franchise <sup>®</sup> Pranchise TinyBoost <sup>™</sup> TinyBuck <sup>™</sup> TinyLogic <sup>®</sup> TINYOPTO <sup>™</sup> TinyPower <sup>™</sup> TinyPWM <sup>™</sup> TinyWire <sup>™</sup> µSerDes <sup>™</sup> UHC <sup>®</sup> Ultra FRFET <sup>™</sup> UniFET <sup>™</sup>
FlashWriter <sup>®*</sup>	®	SuperSOT™8	VCX™

\* EZSWITCH<sup>TM</sup> and FlashWriter<sup>®</sup> are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
  - 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.

### PRODUCT STATUS DEFINITIONS

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC